

**Green Products** 

### STF30H150C SCHOTTKY RECTIFIER

#### **Applications:**

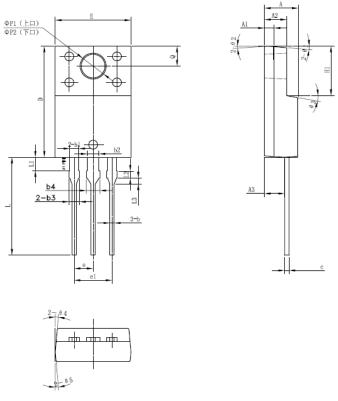
- Switching power supply
- Converters
- Free-Wheeling diodes
- Reverse battery protection

#### Features:

- 175 °C T<sub>J</sub> operation
- Center tap configuration
- Ultralow forward voltage drop
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- This is a Pb Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request



#### **Mechanical Dimensions: In mm**



SYMBOL	MIN.	TYP.	MAX.
Α	4.30	4.50	4.70
A1	1.10	1.30	1.50
A2	2.80	3.00	3.20
A3	2.50	2.70	2.90
b	0.50	0.60	0.75
b1	1.10	1.20	0.75 1.35
b2	1.50	1.60	1.75
b3	1.20	1.30	1.45
b4	1.60	1.70	1.85
c D E	0.55	0.60	0.75
D	14.80	15.00 10.16	15.20
	9.96	10.16	10.36
е		2.55 5.10	
e1		5.10	
H1	6.50	6.70	6.90
L	12.70	13.20	13.70
L1	1.60	1.80	2.00
L2 L3	0.80	1.00	1.20
L3	0.60	0.80	1.00
ΦP1(上口)	3.30	3.50	2.00 1.20 1.00 3.70
ΦP2(下口)	2.99	3.19	3.39
Q	2.50	2.70	2.90
Θ1		5°	
Θ2		4°	
Θ3		10°	
Θ4		5° 5°	
Θ5		5°	

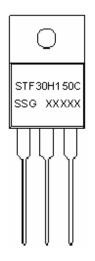
**ITO-220AB** 

- China Germany Korea Singapore United States
  - http://www.smc-diodes.com sales@ smc-diodes.com •



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#### **Marking Diagram:**



Where XXXXX is YYWWL

S = Device Type T = Ultralow VF F = Package type

30 = Forward Current (30A)

 $H = Tj 175^{\circ}C$ 

150 = Reverse Voltage (150V)

C = Configuration

SSG = SSG YY = Year WW = Week L = Lot Number

Cautions: Molding resin

Epoxy resin UL: 94V-0

#### **Ordering Information:**

Device	Package	Shipping
STF30H150C	ITO-220AB	50pcs / tube
	(Pb-Free)	Sopes / tube

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification.

#### **Maximum Ratings:**

Characteristics	Symbol	Condition	Max.	Units
Peak Inverse Voltage	$V_{RWM}$	-	150	V
Average Forward Current	I <sub>F(AV)</sub>	50% duty cycle @T <sub>C</sub> =100°C rectangular wave form	30	Α
Peak One Cycle Non- Repetitive Surge Current (per leg)	I <sub>FSM</sub>	8.3 ms, half Sine pulse	200	А

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#### **Electrical Characteristics:**

Characteristics	Symbol	Condition	Тур.	Max.	Units
Forward Voltage Drop	$V_{F1}$	@ 15A, Pulse, T <sub>J</sub> = 25 °C	0.84	1.36	V
(per leg)*	$V_{F2}$	@ 15A, Pulse, T <sub>J</sub> = 125 °C	0.72	0.79	V
Reverse Current (per leg)*	I <sub>R1</sub>	$@V_R = \text{rated } V_R$ $T_J = 25  ^{\circ}C$	0.2	200	μΑ
	I <sub>R2</sub>	$@V_R = \text{rated } V_R$ $T_J = 125  ^{\circ}\text{C}$	0.33	20	mA
Junction Capacitance (per leg)	C <sub>T</sub>	$@V_R = 5V, T_C = 25 °C f_{SIG} = 1MHz$	485	-	pF
RSM Isolation Voltage(t = 1.0 second, R. H. < =30%, TA = 25 °C)	V <sub>ISO</sub>	Clip mounting, the epoxy body away from the heatsink edge by more than 0.110" along the lead direction	-	4500	V
,		Clip mounting, the epoxy body is inside the heatsink.	-	3500	
		Screw mounting, the epoxy body is inside the heatsink.	-	1500	

<sup>\*</sup> Pulse Width < 300 $\mu$ s, Duty Cycle <2%

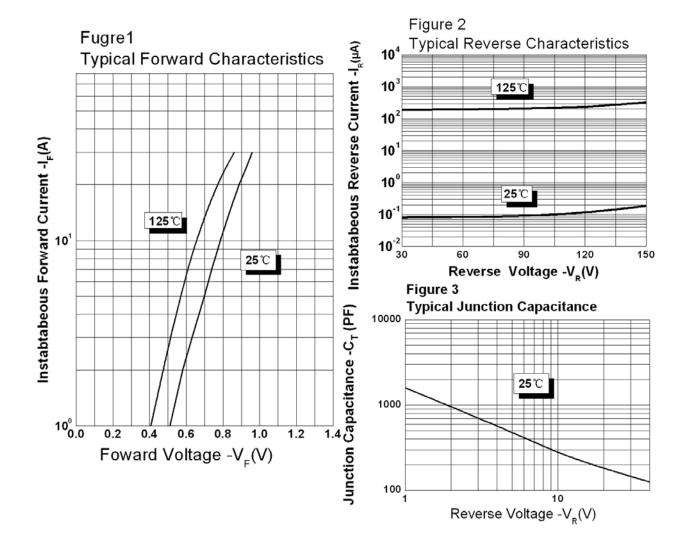
## **Thermal-Mechanical Specifications:**

Characteristics	Symbol	Condition	Specification	Units
Junction Temperature	TJ	-	-55 to +175	°C
Storage Temperature	$T_{stg}$	-	-55 to +175	°C
Maximum Thermal Resistance Junction to Case (per leg)	$R_{ heta JC}$	DC operation	4.5	°C/W
Approximate Weight	wt	-	2	g
Case Style		ITO-220AB		

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